

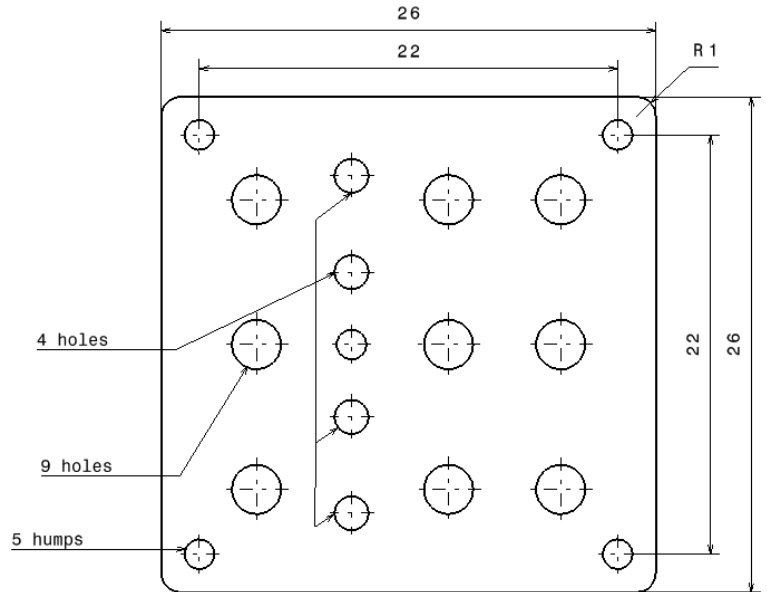
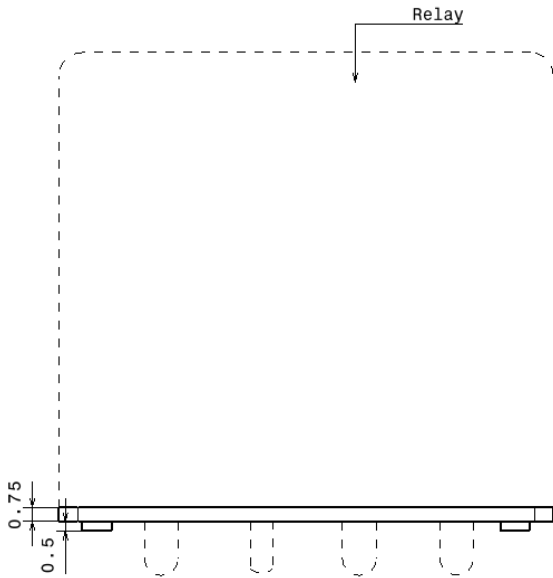


DESIGNED FOR RELAY SERIES:

M500, M501, M502,

F570

Control devices: CS500



- Dimensions are in mm
- Isolation pad is fitted with humps to be positioned on the PCB side. These humps allow the cleaning of the solder Flux.
- Humps diameter : 1.57mm – Humps Height : 0.5mm

GENERAL CHARACTERISTICS
CARACTERISTIQUES GENERALES

| | |
|--|----------------|
| Material <i>Matière</i> | Pocan PBT-GF30 |
| Weight <i>Poids</i> | 1g max |
| Maximum temperature <i>Température maximum</i> | 244°C |
| Flammability rating UL 94 <i>Indice d'inflammabilité UL 94</i> | V-0 |

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The technical information provided by Leach International Europe is to be used as a guide only, and is not meant for publication or as documentation for altering any existing specification. Dimensions are in millimeters unless otherwise specified. Rev. 03/2025